

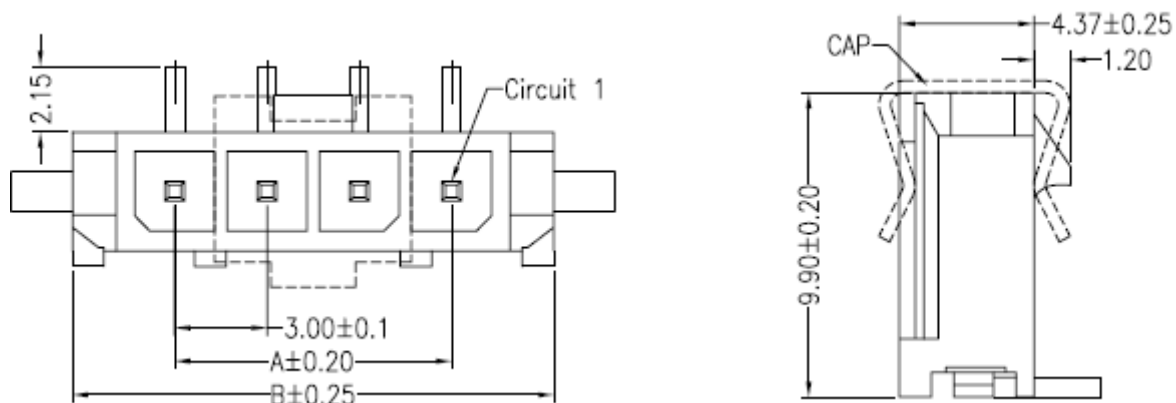
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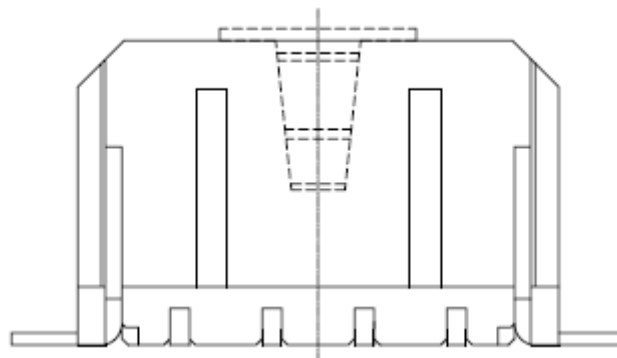
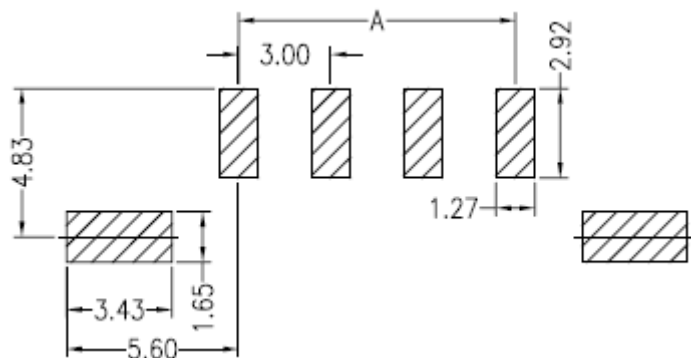
Specifications

Voltage Rating:	250VAC/DC
Current Rating	5,0A
Operating Temperature	-25°C ~ +85°C
Contact Resistance	10m Ohm max.
Withstanding Voltage	1500VAC/Minute
Insulation Resistance	1000M Ohm min.
Contact Material:	Brass
Contact Plating :	AU or Sn over Ni.
Insulator Material:	High Temperature Plastic UL94V-0

Drawing (dimensions all into mm)



Terminal Assembly Drawing



Wafer Serie T68Qxxx Pitch
3,00mm

Part No.: **T68Q019**

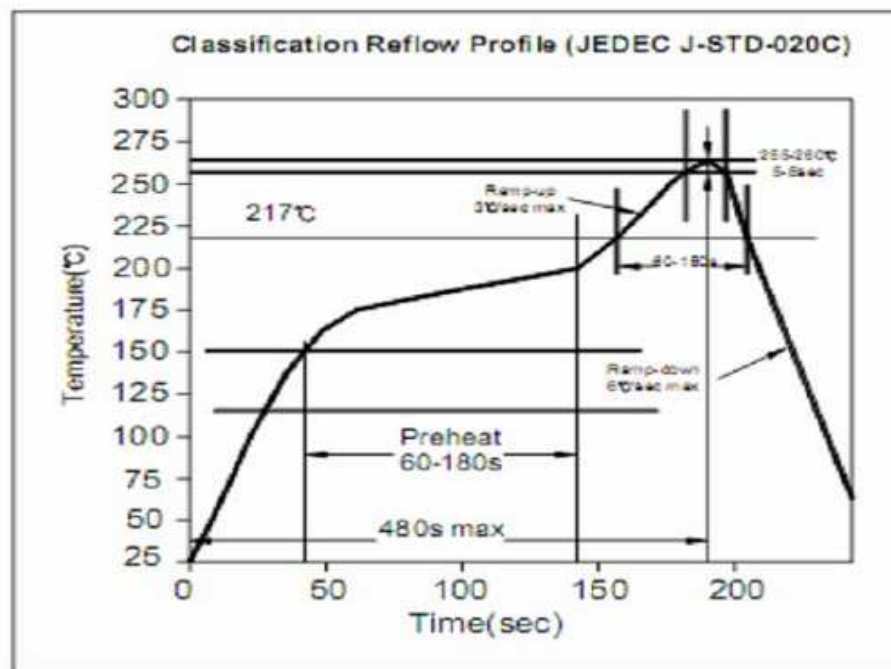
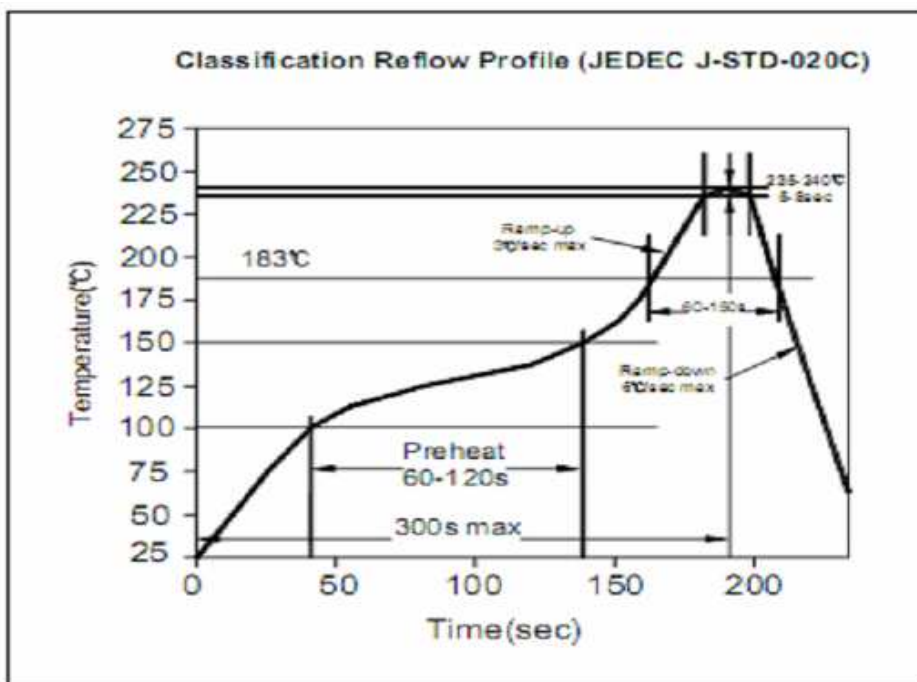
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009	Customer:
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 4		



Soldering Profile

Lead Solder

Lead Free Solder



Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q019
Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	3 from 4	

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Ordering Informations

Serie	Number of	Contact	Packing						
T68Q019	02	T	BU						

xx = Pos.	T= Tin Plated (Standard)	BU= Bulk (Standard)							
		TY= Tray Packing							
	G= Gold Flash Plated	TU= Tube Packing							

Wafer Serie T68Qxxx Pitch 3,00mm	
Part No.:	T68Q019
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DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
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